

**Silicon Power  
Schottky Diode**
**MBRT30045 thru  
MBRT300100R**
 $V_{RRM} = 20 \text{ V} - 100 \text{ V}$   
 $I_F = 300 \text{ A}$ 
**Features**

- High Surge Capability
- Types up to 100 V  $V_{RRM}$
- Isolation Type Package

**Three Tower Package**

**Maximum ratings, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified ("R" devices have leads reversed)**

Parameter	Symbol	Conditions	MBRT30045 (R)	MBRT30060 (R)	MBRT30080 (R)	MBRT300100 (R)	Unit
Repetitive peak reverse voltage	$V_{RRM}$		45	60	80	100	V
RMS reverse voltage	$V_{RMS}$		32	42	57	70	V
DC blocking voltage	$V_{DC}$		45	60	80	100	V
Continuous forward current	$I_F$	$T_c \leq 125^\circ\text{C}$	300	300	300	300	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SU}$	$T_c = 25^\circ\text{C}, t_s = 8.3 \text{ ms}$	2500	2500	2500	2500	A
Operating temperature	$T_j$		-40 to 150	-40 to 150	-40 to 150	-40 to 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-40 to 175	-40 to 175	-40 to 175	-40 to 175	$^\circ\text{C}$

**Electrical characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	MBRT30045 (R)	MBRT30060(R)	MBRT30080 (R)	MBRT300100 (R)	Unit
Diode forward voltage	$V_F$	$I_F = 150 \text{ A}, T_j = 25^\circ\text{C}$	0.75	0.8	0.88	0.88	V
Reverse current	$I_R$	$V_R = 20 \text{ V}, T_j = 25^\circ\text{C}$ $V_R = 20 \text{ V}, T_j = 125^\circ\text{C}$	1	1	1	1	mA

**Thermal characteristics**

Thermal resistance, junction - case	$R_{thJC}$		0.16	0.16	0.16	0.16	$^\circ\text{C/W}$
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# America Semiconductor

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